

# Thyristors

# BT152 series

## GENERAL DESCRIPTION

Glass passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

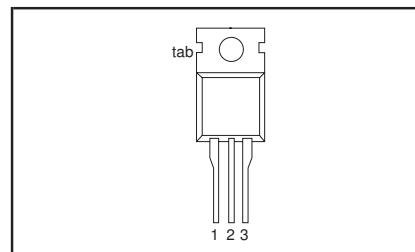
## QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
$V_{DRM}$	Repetitive peak off-state voltages	400R	600R	800R	V
$V_{RRM}$		450	650	800	
$I_{T(AV)}$	Average on-state current	13	13	13	A
$I_{T(RMS)}$	RMS on-state current	20	20	20	A
$I_{TSM}$	Non-repetitive peak on-state current	200	200	200	A

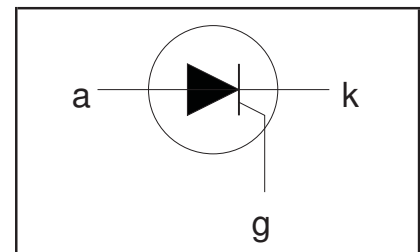
## PINNING - TO220AB

PIN	DESCRIPTION
1	cathode
2	anode
3	gate
tab	anode

## PIN CONFIGURATION



## SYMBOL



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
				-400R 450 <sup>1</sup>	-600R 650 <sup>1</sup>	-800R 800	
$V_{DRM}$	Repetitive peak off-state voltages		-				V
$I_{T(AV)}$	Average on-state current	half sine wave; $T_{mb} \leq 103\text{ °C}$	-		13		A
$I_{T(RMS)}$	RMS on-state current	all conduction angles	-		20		A
$I_{TSM}$	Non-repetitive peak on-state current	half sine wave; $T_j = 25\text{ °C}$ prior to surge	-		200		A
		$t = 10\text{ ms}$	-		220		A
$I^2t$	$I^2t$ for fusing	$t = 8.3\text{ ms}$	-		200		A <sup>2</sup> s
$dI_T/dt$	Repetitive rate of rise of on-state current after triggering	$t = 10\text{ ms}$	-		200		A/ $\mu$ s
		$I_{TM} = 50\text{ A}; I_G = 0.2\text{ A}; dI_G/dt = 0.2\text{ A}/\mu$ s	-		200		
$I_{GM}$	Peak gate current		-		5		A
$V_{GM}$	Peak gate voltage		-		5		V
$V_{RGM}$	Peak reverse gate voltage		-		5		V
$P_{GM}$	Peak gate power		-		20		W
$P_{G(AV)}$	Average gate power	over any 20 ms period	-		0.5		W
$T_{stg}$	Storage temperature		-40		150		°C
$T_j$	Operating junction temperature		-		125		°C

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**THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{thj-mb}$	Thermal resistance junction to mounting base	in free air	-	-	1.1	K/W
$R_{thj-a}$	Thermal resistance junction to ambient		-	60	-	K/W

**STATIC CHARACTERISTICS**

$T_j = 25\text{ °C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{GT}$	Gate trigger current	$V_D = 12\text{ V}; I_T = 0.1\text{ A}$	-	3	32	mA
$I_L$	Latching current	$V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$	-	25	80	mA
$I_H$	Holding current	$V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$	-	15	60	mA
$V_T$	On-state voltage	$I_T = 40\text{ A}$	-	1.4	1.75	V
$V_{GT}$	Gate trigger voltage	$V_D = 12\text{ V}; I_T = 0.1\text{ A}$	-	0.6	1.5	V
$I_D, I_R$	Off-state leakage current	$V_D = V_{DRM(max)}; I_T = 0.1\text{ A}; T_j = 125\text{ °C}$ $V_D = V_{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125\text{ °C}$	0.25	0.4	-	V
			-	0.2	1.0	mA

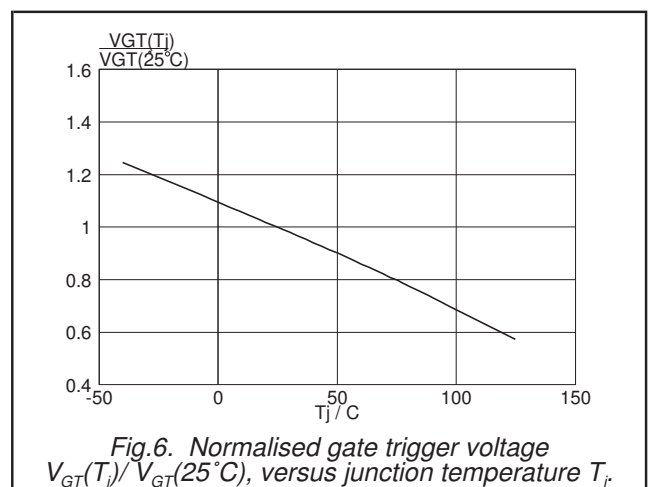
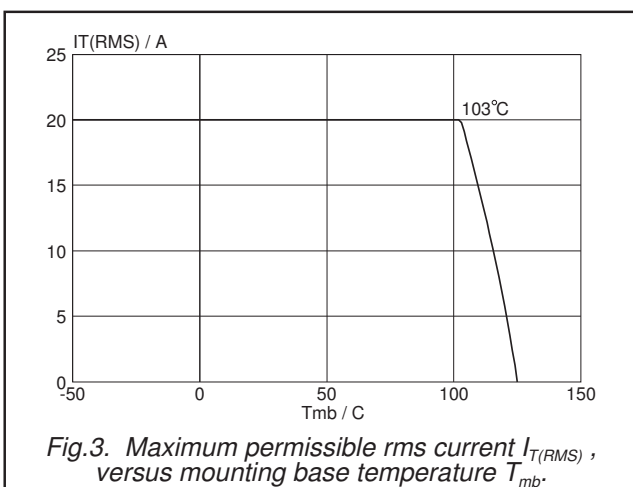
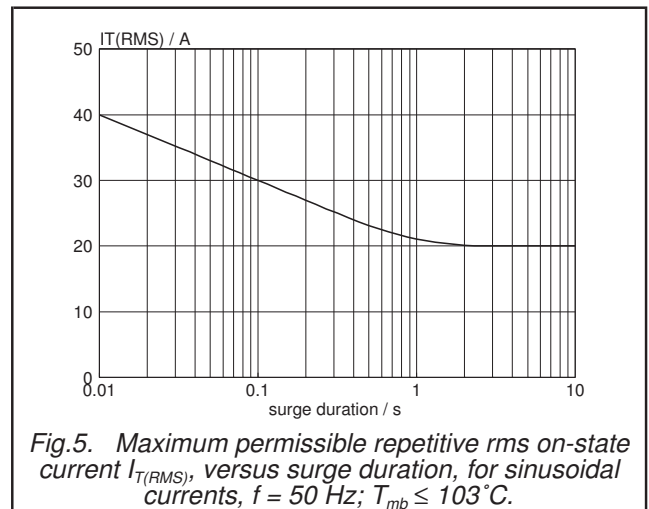
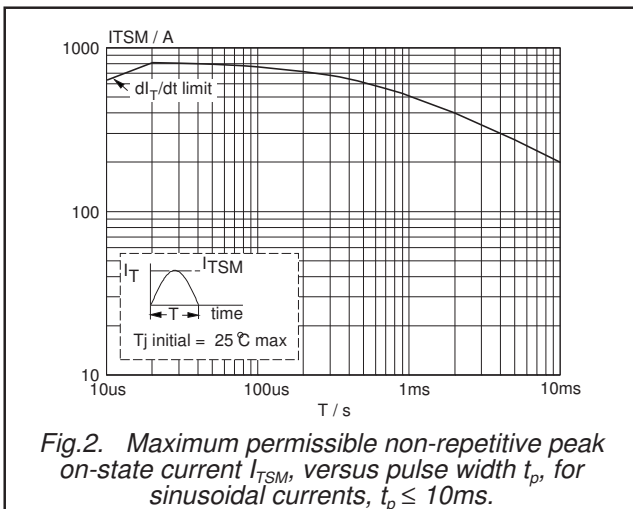
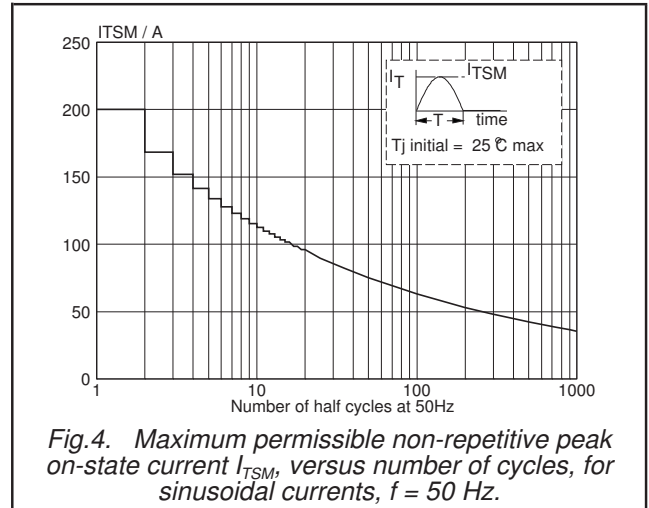
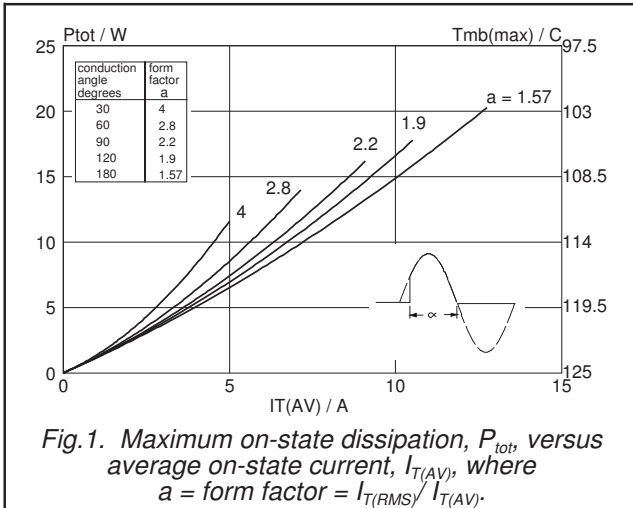
**DYNAMIC CHARACTERISTICS**

$T_j = 25\text{ °C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$dV_D/dt$	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125\text{ °C};$ exponential waveform gate open circuit	200	300	-	V/ $\mu$ s
$t_{gt}$	Gate controlled turn-on time	$V_D = V_{DRM(max)}; I_G = 0.1\text{ A}; dI_G/dt = 5\text{ A}/\mu\text{s};$ $I_{TM} = 40\text{ A}$	-	2	-	$\mu$ s
$t_q$	Circuit commutated turn-off time	$V_D = 67\% V_{DRM(max)}; T_j = 125\text{ °C};$ $I_{TM} = 50\text{ A}; V_R = 25\text{ V}; dI_{TM}/dt = 30\text{ A}/\mu\text{s};$ $dV_D/dt = 50\text{ V}/\mu\text{s}; R_{GK} = 100\ \Omega$	-	70	-	$\mu$ s

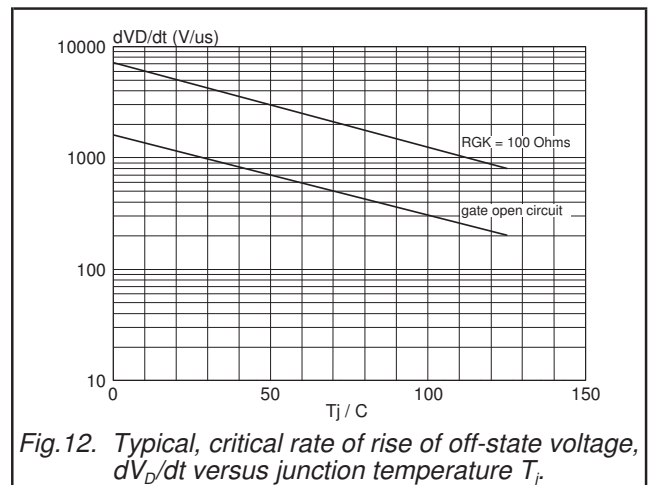
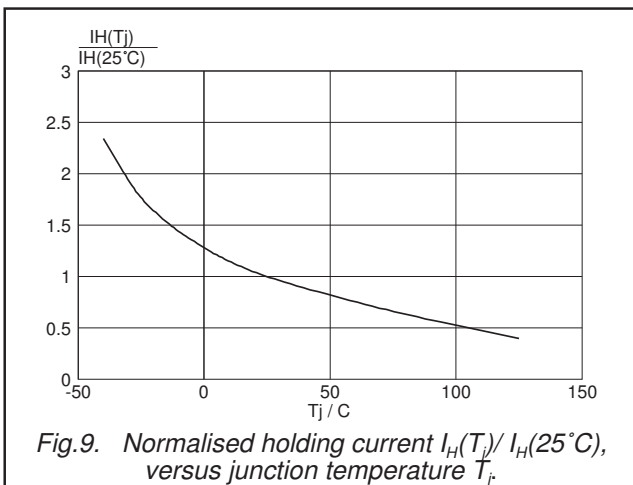
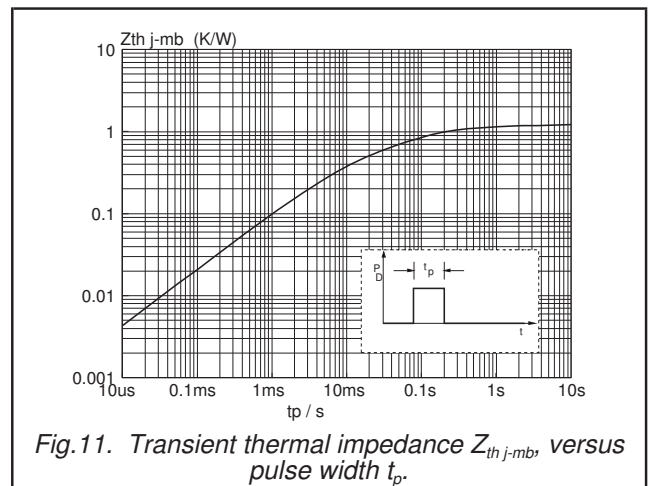
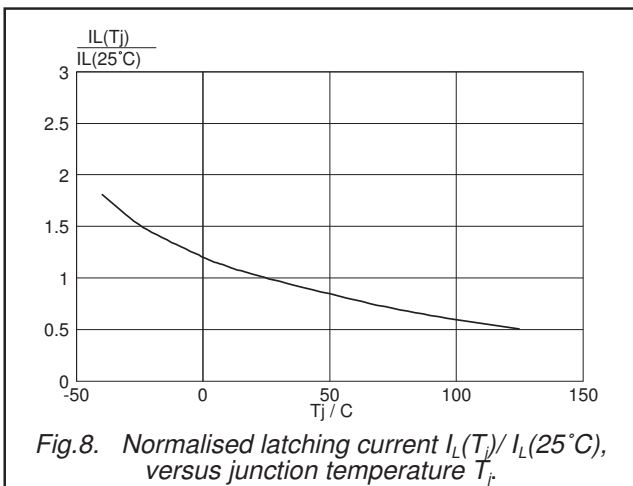
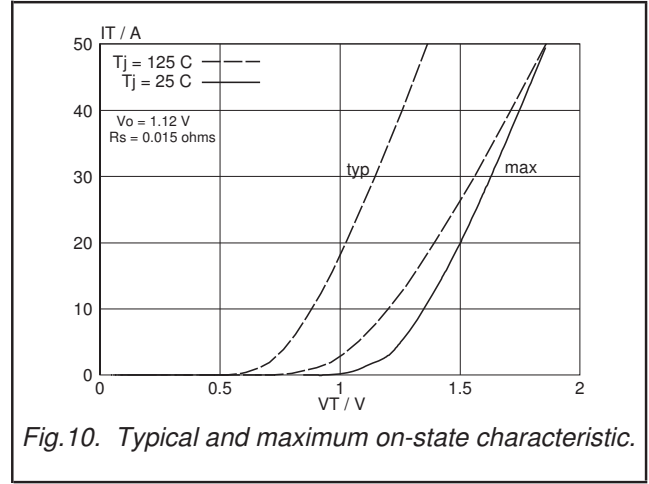
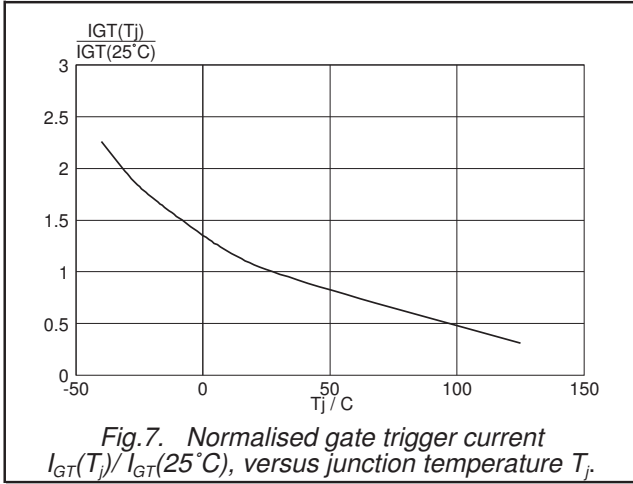
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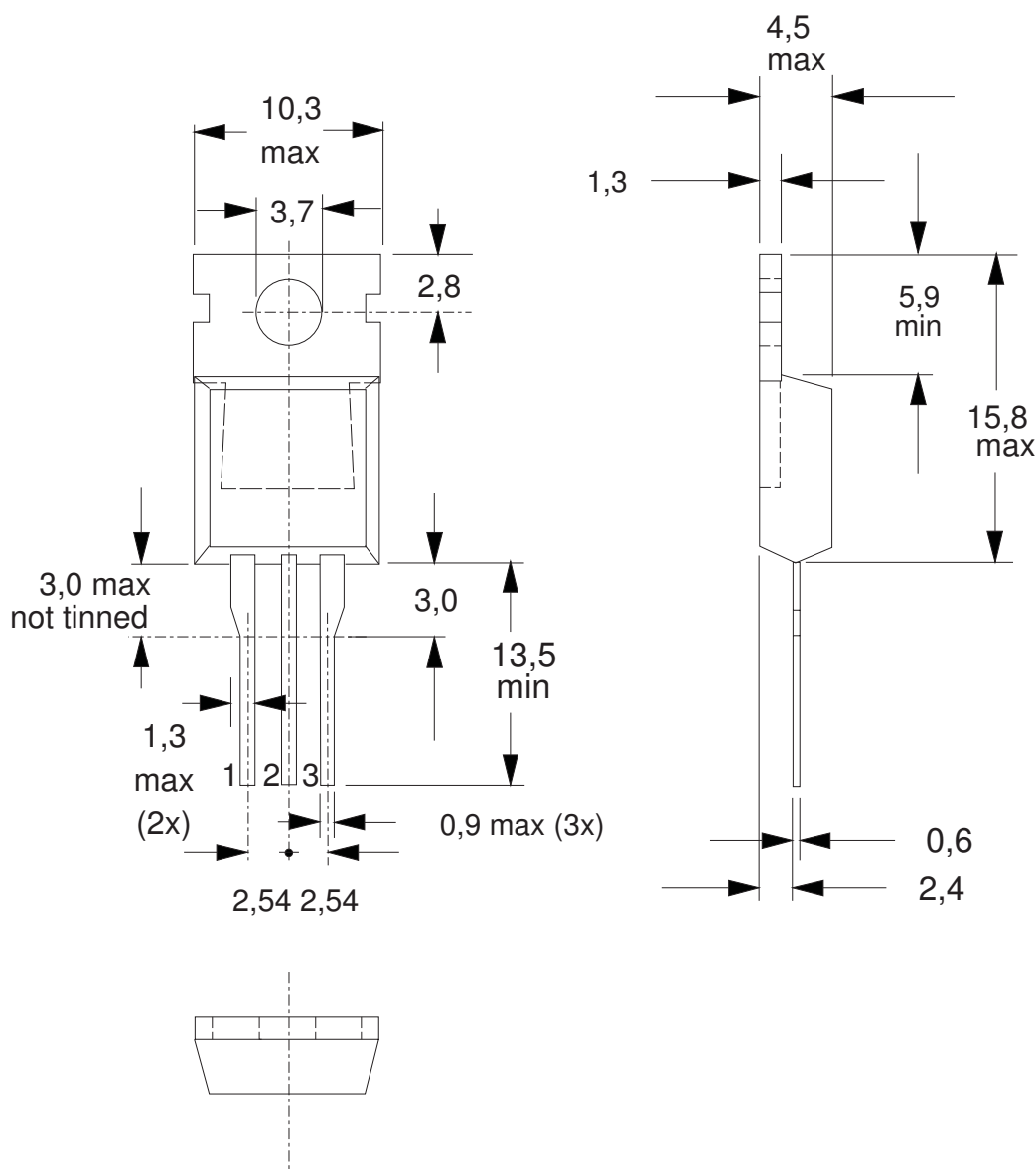
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**MECHANICAL DATA**

*Dimensions in mm*

*Net Mass: 2 g*



*Fig. 13. TO220AB; pin 2 connected to mounting base.*

**Notes**

1. Refer to mounting instructions for TO220 envelopes.
2. Epoxy meets UL94 V0 at 1/8".